# International Rectifier

## IRIS-F6426S

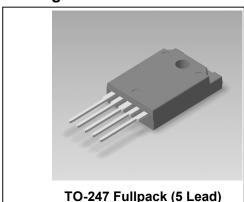
#### **Features**

- Oscillator is provided on the monolithic control with adopting On-Chip-Trimming technology.
- Small temperature characteristics variation by adopting a comparator to compensate for temperature on the control part.
- Low start-up circuit current (100uA max)
- Built-in Active Low-Pass Filter for stabilizing the operation in case of light load
- Avalanche energy guaranteed MOSFET with high VDSS
- The built-in power MOSFET simplifies the surge absorption circuit since the MOSFET guarantees the avalanche energy.
- No VDSS de-rating is required.
- Built-in constant voltage drive circuit
- Built-in step drive circuit
- Built-in low frequency PRC mode (≒20kHz)
- · Various kinds of protection functions
- Pulse-by-pulse Overcurrent Protection (OCP)
- Overvoltage Protection with latch mode (OVP)
- Thermal Shutdown with latch mode (TSD)

#### **Descriptions**

#### INTEGRATED SWITCHER

#### **Package Outline**

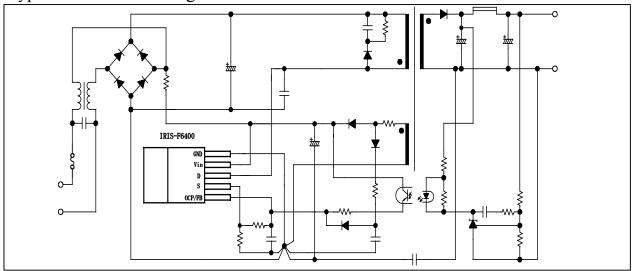


Kev Specifications

	MOSFET	RDS(ON)		Pout(W)
Type	VDSS(V)	MAX	AC input(V)	Note 1
			$100 \pm 15\%$	145
IRIS-F6426S	450	$0.58\Omega$	$120 \pm 15\%$	190

IRIS-F6426S is a hybrid IC consists from power MOSFET and a controller IC, designed for Quasi-Resonant (including low frequency PRC) fly-back converter type SMPS (Switching Mode Power Supply) applications. This IC realizes high efficiency, low noise, downsizing and standardizing of a power supply system reducing external components count and simplifying the circuit designs. (Note). PRC is abbreviation of "Pulse Ratio Control" (On-width control with fixed OFF-time).

#### **Typical Connection Diagram**



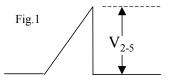


#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to terminals stated, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Terminals	Max. Ratings	Units	Note
IDpeak	Drain Current *1	3-2	16	A	Single Pulse
					V2-5=0.78V
IDMAX	Maximum switching current *5	3-2	16	A	Ta=-20~+125°C
					Single Pulse
EAS	Single pulse avalanche energy *2	3-2	327	mJ	IL peak=6.7A
Vin	Input voltage for control part	4-5	35	V	
Vth	O.C.P/F.B Pin voltage	1-5	6	V	
			52	W	With infintite heatsink
P <sub>D1</sub>	Power dissipation for MOSFET *3	3-2	2.8	W	Without heatsink
	Power dissipation for control part				Specified by
PD2	(Control IC) *4	4-5	0.49	W	Vin×Iin
	Internal frame temperature				Refer to recommended
TF	in operation	-	-20 ~ +125	$^{\circ}\mathbb{C}$	operating temperature
Тор	Operating ambient temperature	-	-20 ~ +125	$^{\circ}\mathbb{C}$	
Tstg	Storage temperature	-	-40 ~ +125	$^{\circ}$	
Tch	Channel temperature	-	150	$^{\circ}$	

The maximum switching current is the Drain current determined by the drive voltage of the IC and threshold voltage (Vth) of MOS FET. Therefore, in the event that voltage drop occurs between Pin 2 and Pin 5 due to patterning, the maximum switching current decreases as shown by  $V_{2-5}$  in Fig.1 Accordingly please use this device within the decrease value, referring to the derating curve of the maximum switching current.



<sup>\*1</sup> Refer to MOS FET A.S.O curve

<sup>\*2</sup> MOS FET Tch-EAS curve

<sup>\*3</sup> Refer to MOS FET Ta-PD1 curve

<sup>\*4</sup> Refer to TF-PD2 curve for Control IC (See page 5)

<sup>\*5</sup> Maximum switching current.

#### **Electrical Characteristics (for Control IC)**

Electrical characteristics for control part (Ta=25°C, Vin=18V,unless otherwise specified)

		Ratings				Test
Symbol	Definition	MIN	TYP	MAX	Units	Conditions
Vin(ON)	Operation start voltage	14.4	16	17.6	V	Vin=0→17. 6V
Vin(OFF)	Operation stop voltage	9	10	11	V	Vin=17.6→9V
Iin(ON)	Circuit current in operation	-	-	20	mA	-
Iin(OFF)	Circuit current in non-operation	-	-	100	μA	Vin=14V
TOFF(MAX)	Maximum OFF time	45	-	55	μsec	-
	Minimum time for input of quasi					
Tth(2)	resonant signals *6	-	-	1	μsec	-
TOFF(MIN)	Minimum OFF time *7	-	-	2	μsec	-
Vth(1)	O.C.P/F.B Pin threshold voltage 1	0.68	0.73	0.78	V	-
Vth(2)	O.C.P/F.B Pin threshold voltage 2	1.3	1.45	1.6	V	
IOCP/FB	O.C.P/F.B Pin extraction current	1.2	1.35	1.5	mA	-
Vin(OVP)	O.V.P operation voltage	20.5	22.5	24.5	V	Vin=0→24. 5V
Iin(H)	Latch circuit sustaining current *8	-	-	400	μΑ	Vin=24.5→8. 5V
Vin(La.OFF)	Latch circuit release voltage *8	6.6	_	8.4	V	Vin=24.5→6. 6V
Tj(TSD)	Thermal shutdown operating temperature	140	-	-	$^{\circ}\!\mathbb{C}$	

<sup>\*6</sup> Refer to Recommended operating conditions

#### **Electrical Characteristics (for MOSFET)**

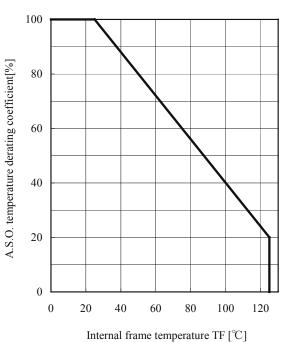
(Ta=25°C) unless otherwise specified

		Ratings				
Symbol	Definition	MIN	TYP	MAX	Units	<b>Test Conditions</b>
						ID=300μA
Vdss	Drain-to-Source breakdown voltage	450	-	-	V	V5-2=0V(short)
						VDS=450V
IDSS	Drain leakage current	_	-	300	μΑ	V5-2=0V(short)
						V5-2=10V
RDS(ON)	On-resistance	-	-	0.58	Ω	ID=3.3A
tf	Switching time	-	-	250	nsec	-
						Between channel and
heta ch-F	Thermal resistance	_	-	1.1	°C/W	internal frame

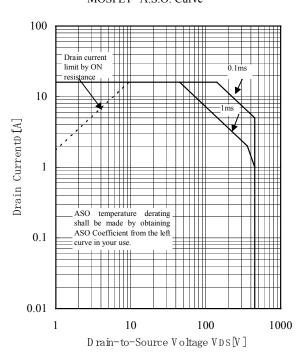
<sup>\*7</sup> The minimum OFF time means Toff width at the time when the minimum quasi resonant signal is inputted.

<sup>\*8</sup> The latch circuit means a circuit operated O.V.P and T.S.D.

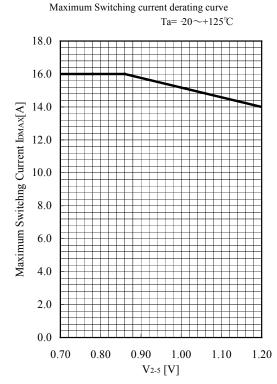
IRIS-F6426S A.S.O. temperature derating coefficient curve



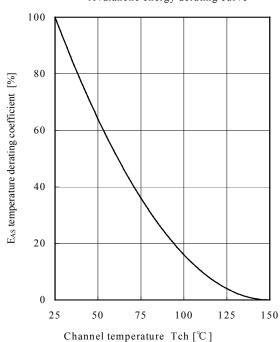
IRIS-F6426S MOSFET A.S.O. Curve



IRIS-F6426S

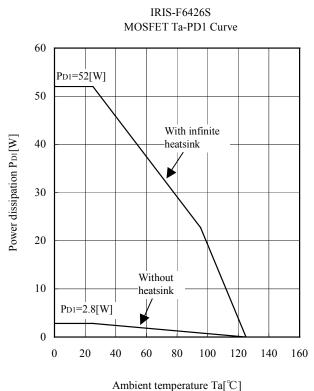


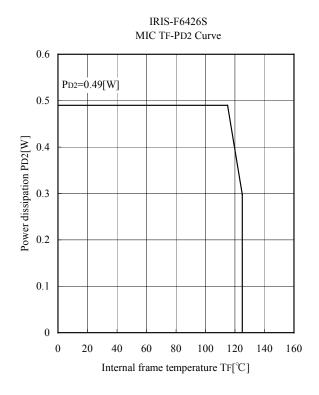
IRIS-F6426S Avalanche energy derating curve

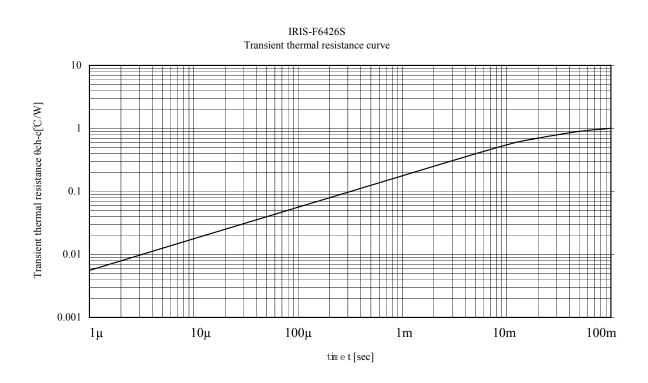


#### **IRIS-F6426S**

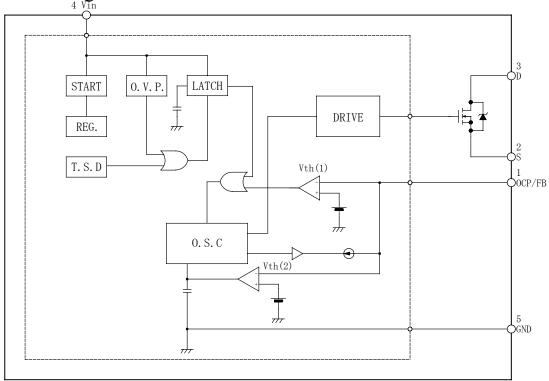
### International IOR Rectifier



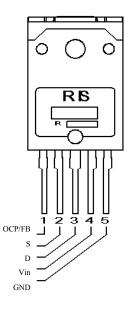




# Block Diagram



# Lead Assignments



Pin No.	Symbol	Description	Function		
		Overcurrent / Feedback	Input of overcurrent detection		
1	OCP/FB	Pin	signal / constant voltage control signal		
2	S	Source Pin	MOSFET source		
3	D	Drain Pin	MOSFET drain		
4	Vin	Power supply Pin	Input of power supply for control circuit		
5	GND	Ground Pin	Ground		

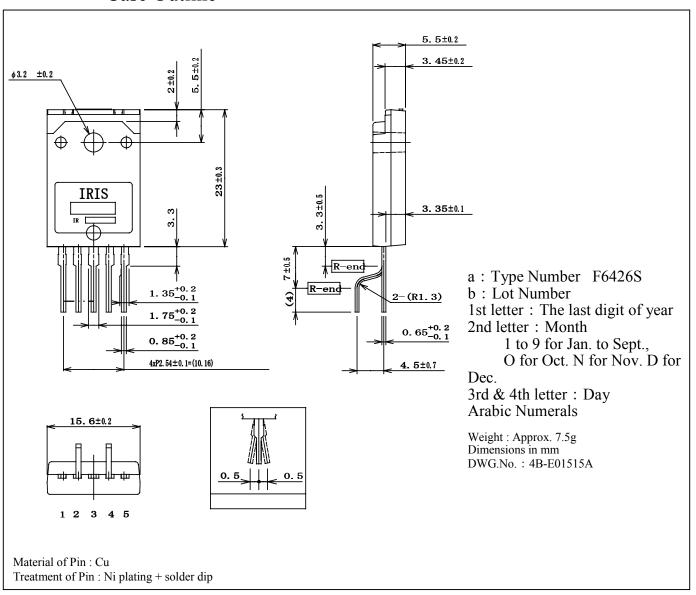
#### Other Functions

O.V.P. – Overvoltage Protection Circuit

T.S.D. – Thermal Shutdown Circuit

STEP DRV – 2 step drive circuit

#### Case Outline



Data and specifications subject to change without notice.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC FAX: (310) 252-7903

Visit us at www.irf.com for sales contact information.